

## **Product Change Notification: CAAN-13UUGL810**

Date:

09-Sep-2024

## **Product Category:**

**Ethernet PHYs** 

# **Notification Subject:**

CCB 6729 Final Notice: Qualification of ASEM as an additional assembly site for selected KSZ8001 and KSZ8721 device families available in 48L LQFP (7x7x1.4mm) package.

#### **Affected CPNs:**

CAAN-13UUGL810\_Affected\_CPN\_09092024.pdf CAAN-13UUGL810\_Affected\_CPN\_09092024.csv

#### **Notification Text:**

**PCN Status:**Final Notification

PCN Type:Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of ASEM as an additional assembly site for selected KSZ8001 and KSZ8721 device families available in 48L LQFP (7x7x1.4mm) package.

## **Pre and Post Change Summary:**

	Pre Change	Post Change					
Assembly Site	Orient Semiconductor Electronics, Ltd (OSE)	Orient Semiconductor Electronics, Ltd (OSE)	ASE Group - Malaysia (ASEM)				
Wire Material	Au	Au	Au				

Die Attach	1	8340	8340	3230					
Material	2	QMI-550	QMI-550	HR-5104T-25					
	compound erial	CEL9200HF	CEL9200HF	CEL 9240HF10AK-G1					
Lead-Fram	e Material	C7025	C7025	C7025					
Lead-Frame	Paddle Size	160x160 mil	160x160 mil	150X150 mil					
DAP Surf	ace Prep	Double Ring Plating	Double Ring Plating	Ring plating					
Lead-fran	ne Design	See Pre and Post Change attachment for lead frame comparison.							

## Impacts to Data Sheet:None

#### Change ImpactNone

**Reason for Change:**To improve on-time delivery performance by qualifying ASEM as an additional assembly site.

**Change Implementation Status:**In Progress

Estimated First Ship Date:October 11, 2024 (date code: 2441)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### **Time Table Summary:**

	December 2023				>	September 2024				October 2024					
Workweek	48	49	50	51	52		36	37	38	39	40	41	42	43	44
Initial PCN Issue Date			Х												
Qual Report Availability								Х							
Final PCN Issue Date								Х							
Estimated Implementation Date												х			

Method to Identify Change:Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:**December 15, 2023: Issued initial notification.

September 09, 2024: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on October 11, 2024.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### Attachments:

PCN\_CAAN-13UUGL810\_Pre and Post Change Summary.pdf PCN\_CAAN-13UUGL810\_Qualification\_Report.pdf

Please contact your local **Microchip sales office** with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the **PCN home page** select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

KSZ8001L

KSZ8001LI

KSZ8001L-TR

KSZ8001LI-TR

KSZ8721BL

KSZ8721BLI

KSZ8721BL-TR

KSZ8721BLI-TR

KSZ8721CL

KSZ8721CL-TR

Date: Sunday, September 8, 2024